Quad 2-input NAND Schmitt trigger Rev. 1 — 4 April 2013

General description 1.

The 74LVC132A-Q100 provides four 2-input NAND gates with Schmitt trigger inputs. It can transform slowly changing input signals into sharply defined, jitter-free output signals.

The inputs switch at different points for positive and negative-going signals. The difference between the positive voltage V_{T+} and the negative voltage V_{T-} is defined as the input hysteresis voltage V_H.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environment.

This product has been gualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

Features and benefits 2.

- Automotive product gualification in accordance with AEC-Q100 (Grade 1) Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Wide supply voltage range from 1.2 V to 3.6 V
- 5 V tolerant inputs for interfacing with 5 V logic
- CMOS low-power consumption
- Direct interface with TTL levels
- Unlimited input rise and fall times
- Inputs accept voltages up to 5.5 V
- Complies with JEDEC standard JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

Applications 3.

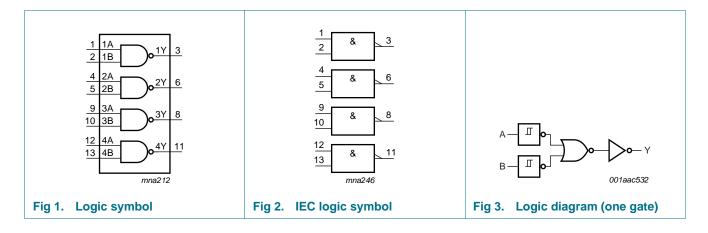
- Wave and pulse shapers for highly noisy environments
- Astable multivibrator
- Monostable multivibrator.



4. Ordering information

Table 1. Ordering information							
Type number	Package						
	Temperature range	Name	Description	Version			
74LVC132AD-Q100	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1			
74LVC132APW-Q100	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1			
74LVC132ABQ-Q100	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1			

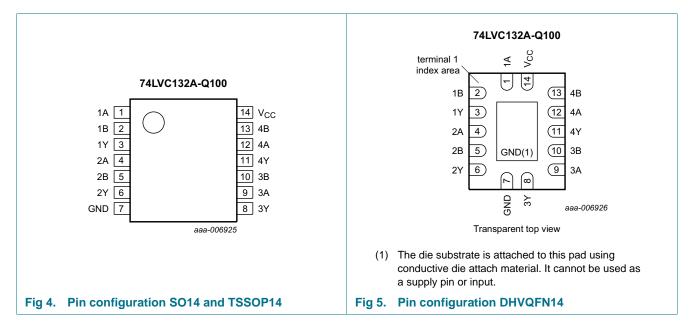
5. Functional diagram



Quad 2-input NAND Schmitt trigger

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1A	1	data input
1B	2	data input
1Y	3	data output
2A	4	data input
2B	5	data input
2Y	6	data output
GND	7	ground (0 V)
3Y	8	data output
3A	9	data input
3B	10	data input
4Y	11	data output
4A	12	data input
4B	13	data input
V _{CC}	14	supply voltage

Functional description 7.

Function table^[1] Table 3.

Input		Output
nA	nB	nY
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

[1] H = HIGH voltage level;

L = LOW voltage level.

Limiting values 8.

Table 4. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Vo	output voltage		[2][3] -0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
lo	output current	$V_{O} = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[4]</u> _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

- The output voltage ratings may be exceeded if the output current ratings are observed. [2]
- When V_{CC} = 0 V (Power-down mode), the output voltage can be 3.6 V in normal operation. [3]

For SO14 packages: Ptot derates linearly with 8 mW/K above 70 °C. [4] For TSSOP14 packages: Ptot derates linearly with 5.5 mW/K above 60 °C. For DHVQFN14 packages: Ptot derates linearly with 4.5 mW/K above 60 °C.

Recommended operating conditions 9.

Table 5.	Recommended operating conditions							
Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
V _{CC}	supply voltage		1.65	-	3.6	V		
		functional	1.2	-	-	V		
VI	input voltage		0	-	5.5	V		
Vo	output voltage		0	-	V _{CC}	V		
T _{amb}	ambient temperature		-40	-	+125	°C		

74LVC132A Q100 **Product data sheet**

Quad 2-input NAND Schmitt trigger

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Мах	Unit
T _{amb} = -	40 °C to +85 °C					
V _{OH}	HIGH-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_O = $-100~\mu\text{A};~V_{CC}$ = 1.65 V to 3.6 V	$V_{CC}-0.2$	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	$V_{CC}-0.45$	-	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	$V_{CC}-0.5$	-	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	$V_{CC}-0.5$	-	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	$V_{CC}-0.6$	-	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	$V_{CC}-0.8$	-	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{T+} \text{ or } V_{T-}$				
		I_O = 100 $\mu\text{A};V_{CC}$ = 1.65 V to 3.6 V	-	-	0.2	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	V
		I_{O} = 12 mA; V_{CC} = 2.7 V	-	-	0.4	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	V
l _l	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	μA
I _{CC}	supply current	V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0 A	-	0.1	10	μA
∆l _{CC}	additional supply current	per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A	-	5	500	μΑ
CI	input capacitance	V_{CC} = 0 V to 3.6 V; V_{I} = GND to V_{CC}	-	4.0	-	pF
T _{amb} = –	40 °C to +125 °C					
V _{ОН}	HIGH-level output voltage	$V_{I} = V_{T+} \text{ or } V_{T-}$				
		I_O = –100 $\mu\text{A};V_{CC}$ = 1.65 V to 3.6 V	$V_{CC}-0.3$	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	$V_{CC}-0.6$	-	-	V
		$I_O = -8$ mA; $V_{CC} = 2.3$ V	$V_{CC}-0.65$	-	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	$V_{CC}-0.65$	-	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	$V_{CC}-0.75$	-	-	V
		$I_O = -24$ mA; $V_{CC} = 3.0$ V	$V_{CC}-1$	-	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{T+} \text{ or } V_{T-}$				
		I_O = 100 $\mu\text{A};V_{CC}$ = 1.65 V to 3.6 V	-	-	0.3	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.8	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.8	V
lı	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	-	±20	μA
I _{CC}	supply current	V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0 A	-	-	40	μA
Δl _{CC}	additional supply current	per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A	-	-	5	mA

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

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74LVC132A_Q100

5 of 16

Quad 2-input NAND Schmitt trigger

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions	Conditions		–40 °C to +85 °C			–40 °C to +125 °C	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	nA, nB to nY; see Figure 6	[2]						
		V _{CC} = 1.2 V		-	18.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.0	7.2	12.8	2.0	16.0	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	4.0	7.6	1.5	9.6	ns
		$V_{CC} = 2.7 V$		1.5	3.8	7.6	1.5	9.6	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.4	6.4	1.5	8.0	ns
t _{sk(o)}	output skew time		[3]	-	-	1.0	-	1.5	ns
C _{PD} power dissipation capacitance		per buffer; $V_I = GND$ to V_{CC}	[4]						
	capacitance	V_{CC} = 1.65 V to 1.95 V		-	10.5	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V		-	10.8	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V		-	11.4	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

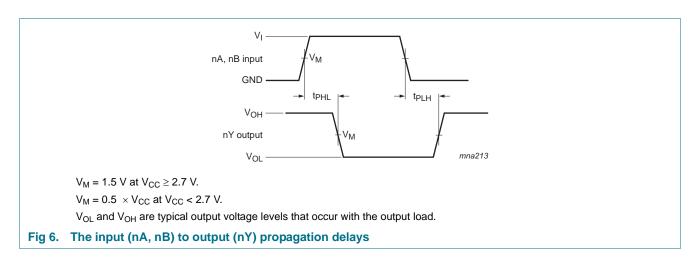
 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

12. Waveforms



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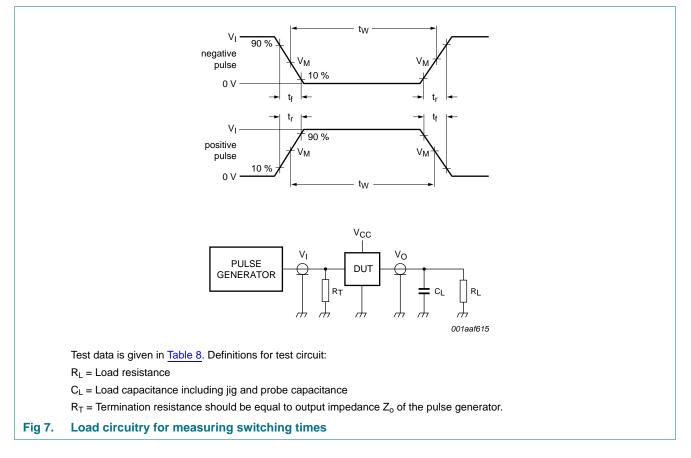


Table 8. Test data

Supply voltage	Input		Load	Load		
	VI	t _r , t _f	C∟	RL		
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ		
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ		
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω		
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω		
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω		

Quad 2-input NAND Schmitt trigger

13. Transfer characteristics

Table 9. Transfer characteristics

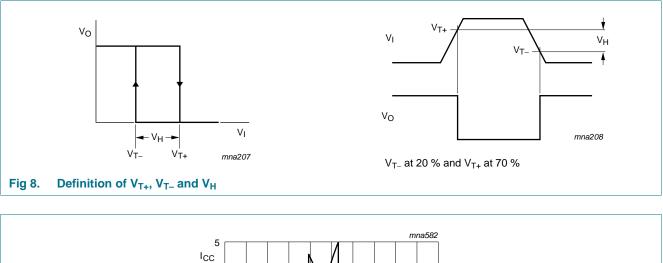
Voltages are referenced to GND (ground = 0 V); see <u>Figure 8</u>.

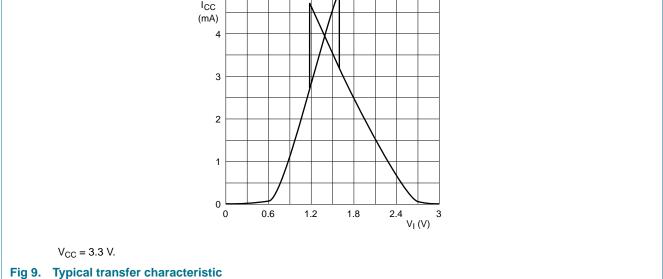
Symbol Parameter		Conditions		-40 °C 1	to +85 °C	–40 °C to	Unit	
				Min	Max	Min	Max	
V _{T+}	positive-going	V _{CC} = 1.2 V		0.2	1.0	0.2	1.0	V
	threshold voltage	V _{CC} = 1.65 V		0.4	1.3	0.4	1.3	V
		V _{CC} = 1.95 V		0.6	1.5	0.6	1.5	V
		$V_{CC} = 2.3 V$		0.8	1.7	0.8	1.7	V
		$V_{CC} = 2.5 V$		0.9	1.7	0.9	1.7	V
		$V_{CC} = 2.7 V$		1.1	2	1.1	2	V
		$V_{CC} = 3 V$		1.2	2	1.2	2	V
		V _{CC} = 3.6 V		1.2	2	1.2	2	V
V _{T-}	negative-going	V _{CC} = 1.2 V		0.12	0.75	0.12	0.75	V
	threshold voltage	V _{CC} = 1.65 V		0.15	0.85	0.15	0.85	V
		V _{CC} = 1.95 V		0.25	0.95	0.25	0.95	V
		$V_{CC} = 2.3 V$		0.4	1.1	0.4	1.1	V
		$V_{CC} = 2.5 V$		0.4	1.2	0.4	1.2	V
		$V_{CC} = 2.7 V$		0.8	1.4	0.8	1.4	V
		$V_{CC} = 3 V$		0.8	1.5	0.8	1.5	V
		V _{CC} = 3.6 V		0.8	1.5	0.8	1.5	V
V _H	hysteresis voltage	$(V_{T+} - V_{T-})$						
		V _{CC} = 1.2 V		0.1	1.0	0.1	1.0	V
		V _{CC} = 1.65 V		0.2	1.15	0.2	1.15	V
		V _{CC} = 1.95 V		0.2	1.25	0.2	1.25	V
		$V_{CC} = 2.3 V$		0.3	1.3	0.3	1.3	V
		$V_{CC} = 2.5 V$		0.3	1.3	0.3	1.3	V
		$V_{CC} = 2.7 V$		0.3	1.1	0.3	1.1	V
		$V_{CC} = 3 V$		0.3	1.2	0.3	1.2	V
		V _{CC} = 3.6 V	<u>[1]</u>	0.3	1.2	0.3	1.2	V

[1] Typical transfer characteristic is displayed in Figure 9.

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14. Waveforms transfer characteristics





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15. Package outline

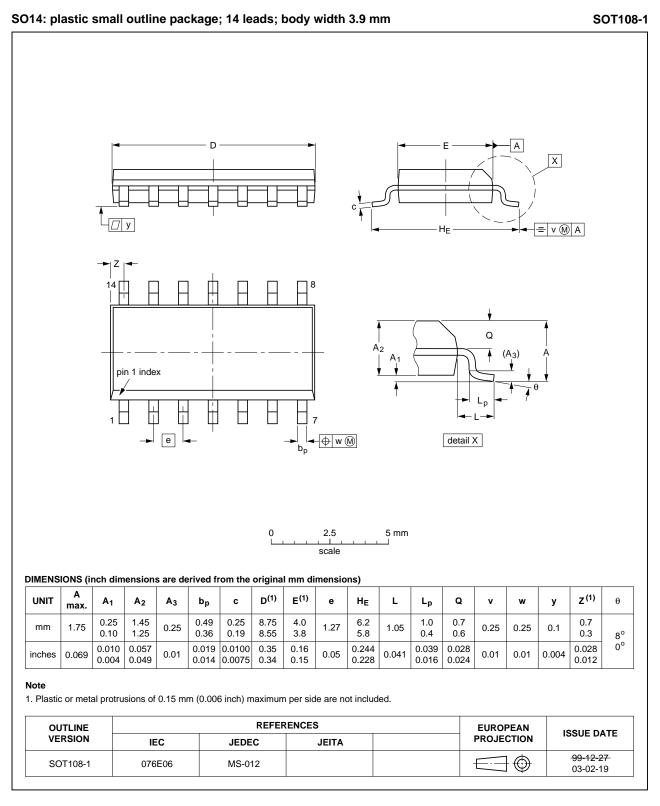


Fig 10. Package outline SOT108-1 (SO14)

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74LVC132A_Q100

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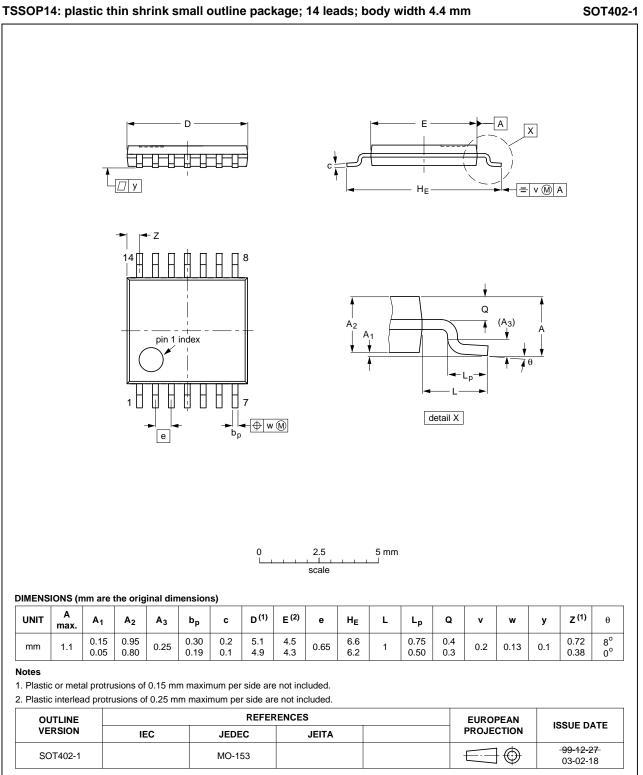
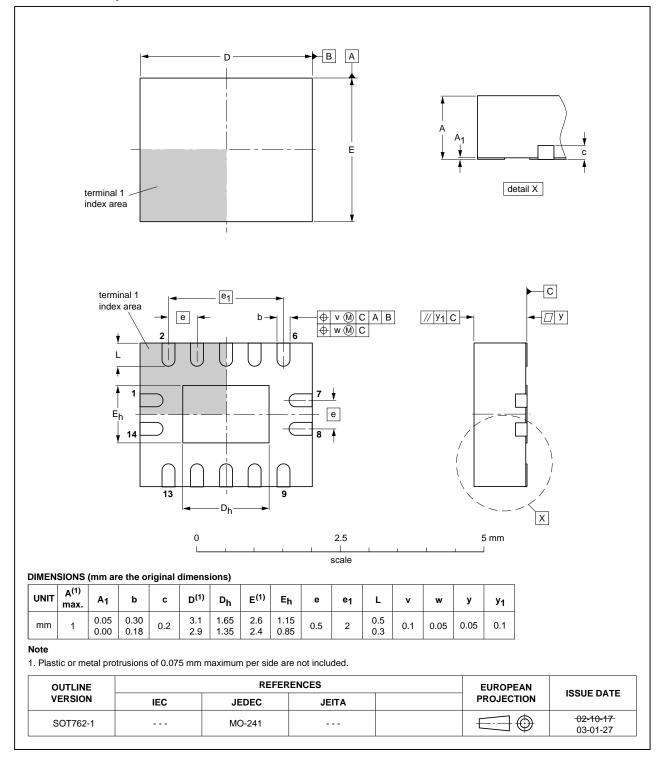


Fig 11. Package outline SOT402-1 (TSSOP14)

74LVC132A_Q100



DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 12. Package outline SOT762-1 (DHVQFN14)

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74LVC132A_Q100

Quad 2-input NAND Schmitt trigger

16. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

17. Revision history

Table 11. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC132A_Q100 v.1	20130404	Product data sheet	-	-	

18. Legal information

18.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Quad 2-input NAND Schmitt trigger

20. Contents

1	General description 1
2	Features and benefits 1
3	Applications 1
4	Ordering information 2
5	Functional diagram 2
6	Pinning information 3
6.1	Pinning 3
6.2	Pin description 3
7	Functional description 4
8	Limiting values 4
9	Recommended operating conditions 4
10	Static characteristics 5
11	Dynamic characteristics 6
12	Waveforms
13	Transfer characteristics 8
14	Waveforms transfer characteristics
15	Package outline 10
16	Abbreviations 13
17	Revision history 13
18	Legal information 14
18.1	Data sheet status 14
18.2	Definitions 14
18.3	Disclaimers 14
18.4	Trademarks 15
19	Contact information 15
20	Contents 16

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